

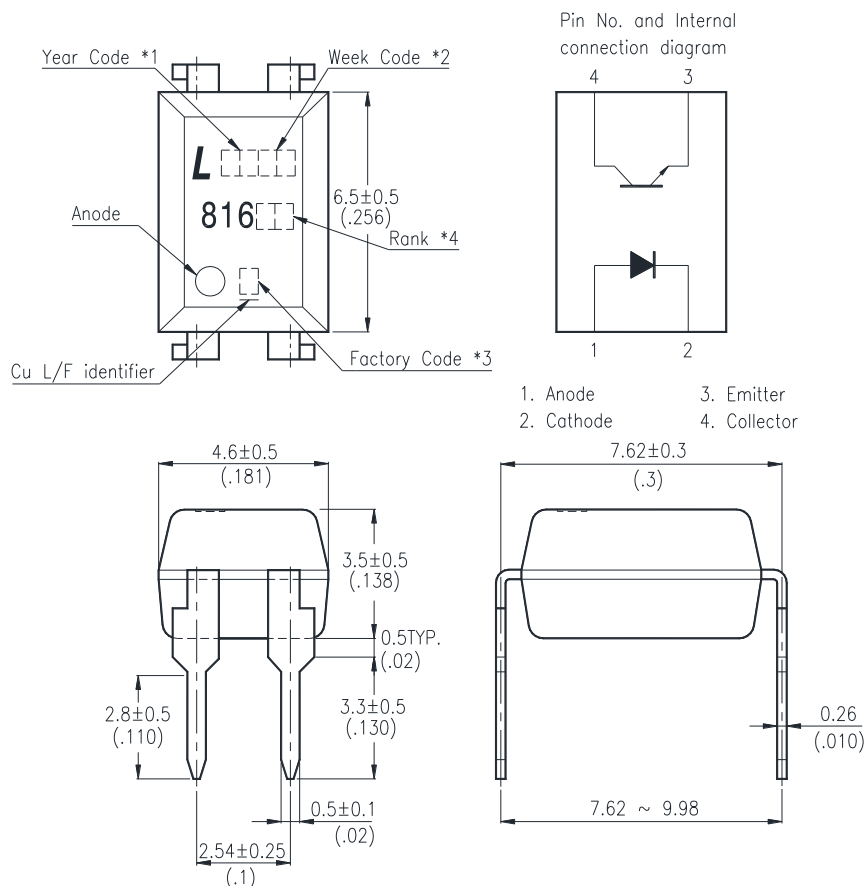


## FEATURES

- \* Current transfer ratio  
( CTR : MIN. 50% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- \* High input-output isolation voltage  
(  $V_{iso} = 5,000\text{V}_{rms}$  )
- \* Response time  
(  $t_r$  : TYP.  $4\mu\text{s}$  at  $V_{CE} = 2\text{V}$ ,  $I_C = 2\text{mA}$ ,  $R_L = 100\Omega$  )
- \* Dual-in-line package :  
LTV-816-Cu : 1-channel type
- \* Wide lead spacing package :  
LTV-816M-Cu : 1-channel type
- \* Surface mounting package :  
LTV-816S-Cu : 1-channel type
- \* Tape and reel packaging :  
LTV-816S-TA-Cu : 1-channel type  
LTV-816S-TA1-Cu : 1-channel type  
LTV-816S-TP-Cu : 1-channel type
- \* Safety approval  
UL 1577, Cert. No.E113898  
CSA CA5A, Cert. No. 1020087 (CA 91533-1)  
FIMKO EN/IEC 60950-1, EN/IEC 60065; Cert. No.NCS/FI 24426 M3  
NEMKO EN/IEC 60950-1,EN/IEC 60065; Cert. No.P08209622/A1  
DEMKO EN/IEC 60950-1,EN/IEC 60065; Cert. No.314703-02  
SEMKO EN/IEC 60950-1,EN/IEC 60065; Cert. No. 1119078  
VDE DIN EN60747-5-5, Cert. No. 40015248  
CQC GB8898-2011/GB4943-2011, Cert.No.  
CQC10001054420/CQC10001054421
- \* RoHS compliance  
All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- \* ESD pass HBM 8000V/MM2000V
- \*MSL class1
- \*Copper base lead frame

## OUTLINE DIMENSIONS

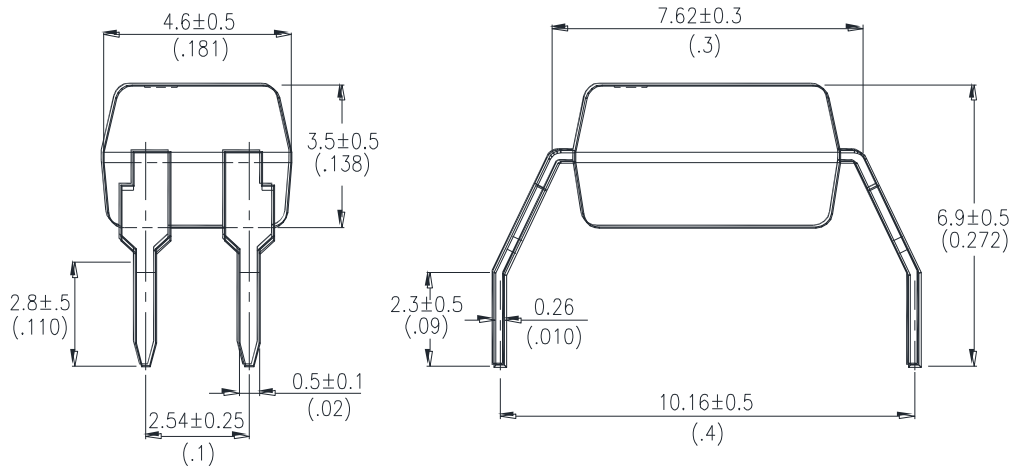
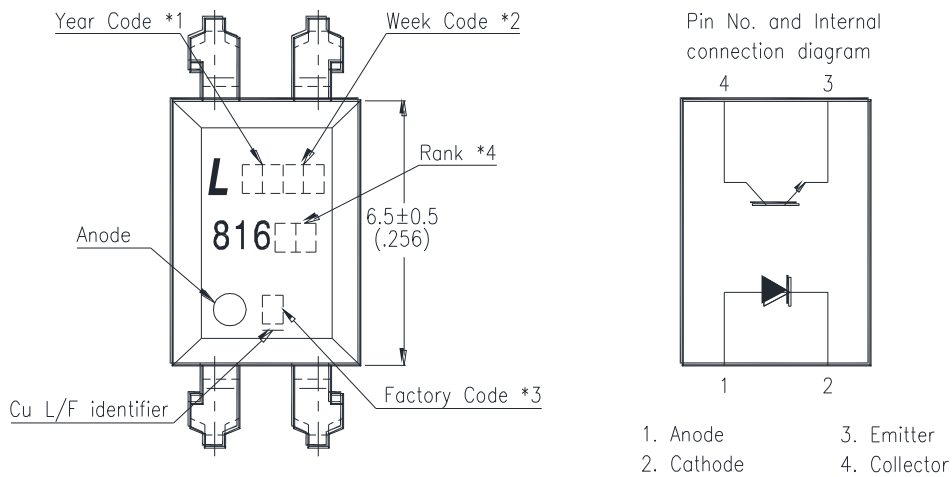
### LTV-816-Cu:



- \*1. Year date code.
- \*2. 2-digit work week.
- \*3. Factory identification mark shall be marked.  
(Y : Thailand, W : China-CZ)
- \*4. Rank shall be or shall not be marked.

## OUTLINE DIMENSIONS

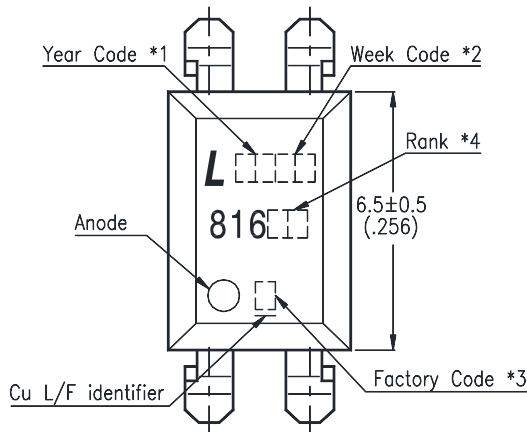
### LTV-816M-Cu :



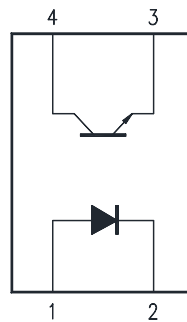
- \*1. Year date code.
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## OUTLINE DIMENSIONS

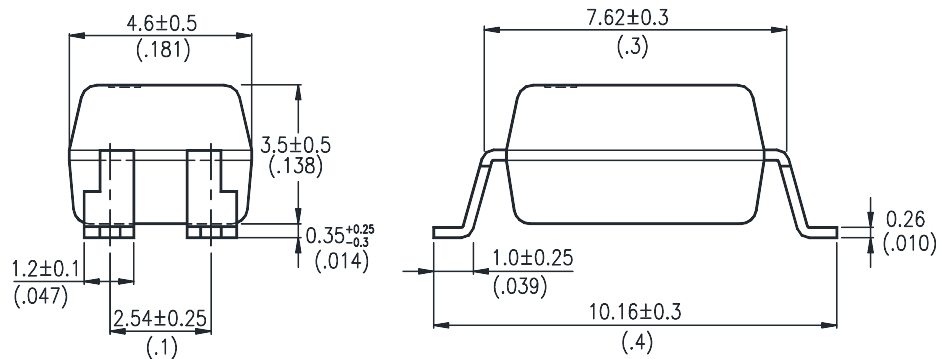
### LTV-816S-Cu :



Pin No. and Internal connection diagram



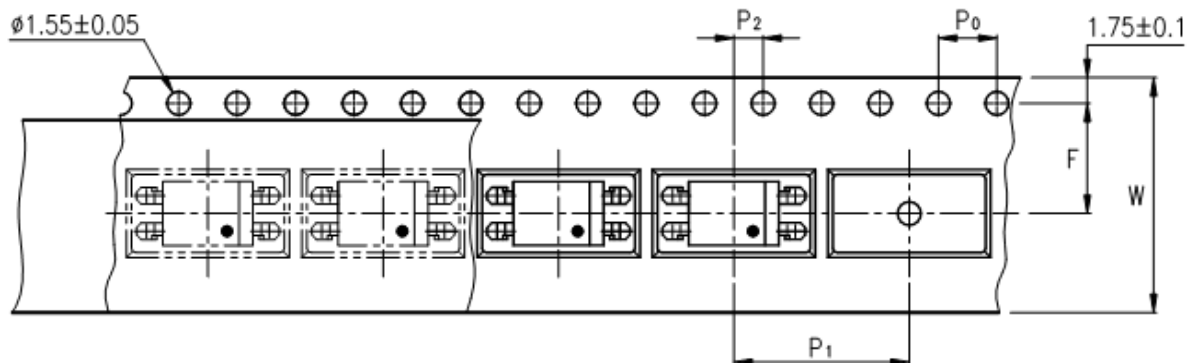
- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector



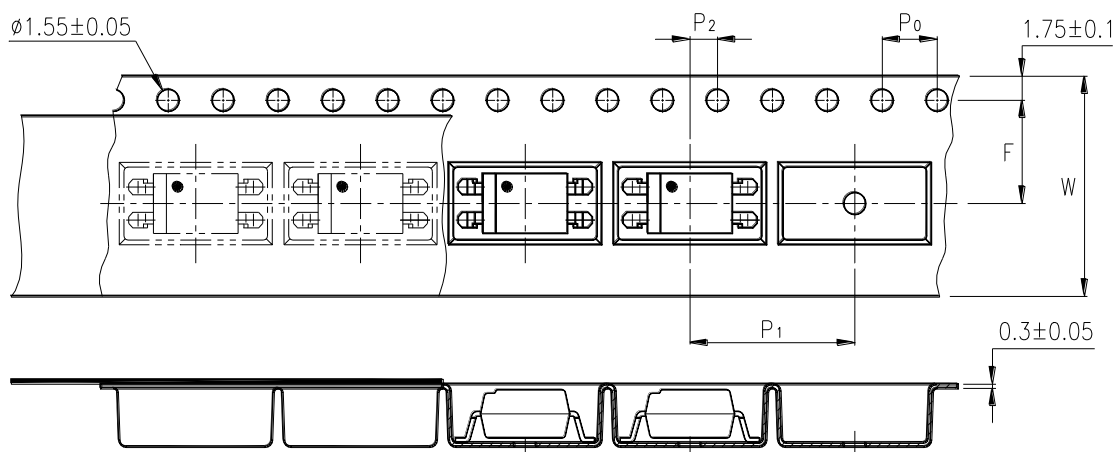
- \*1. Year date code.
- \*2. 2-digit work week.
- \*3. Factory identification mark shall be marked.  
(Y : Thailand, W : China-CZ)
- \*4. Rank shall be or shall not be marked.

## TAPING DIMENSIONS

**LTV-816S-TA :**



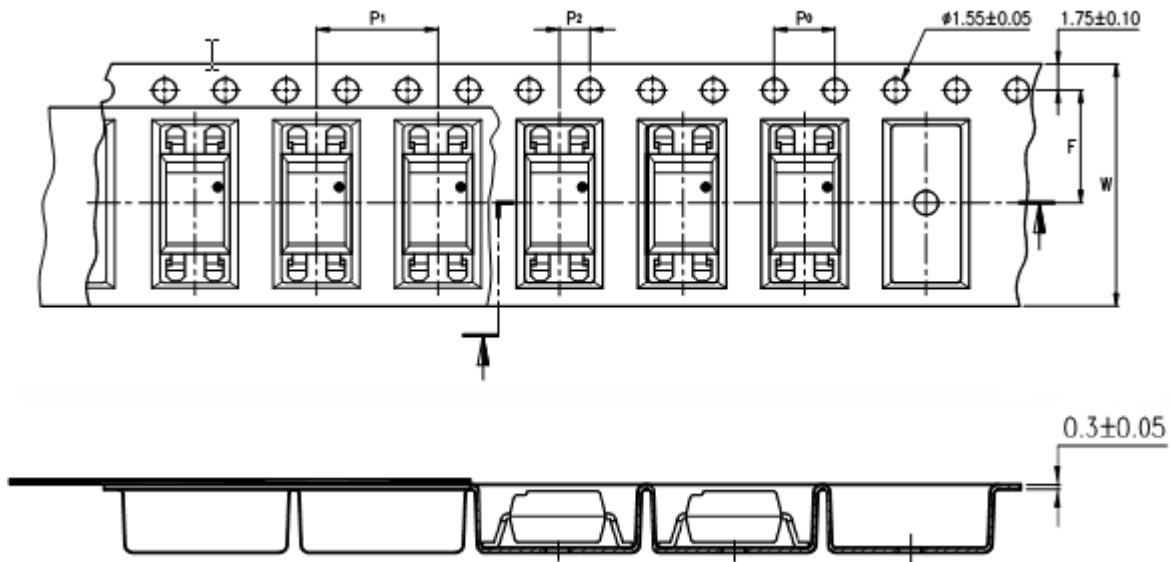
**LTV-816S-TA1 :**



Description	Symbol	Dimensions in mm ( inches )
Tape wide	W	$16 \pm 0.3$ ( .63 )
Pitch of sprocket holes	$P_0$	$4 \pm 0.1$ ( .15 )
Distance of compartment	F	$7.5 \pm 0.1$ ( .295 )
	$P_2$	$2 \pm 0.1$ ( .079 )
Distance of compartment to compartment	$P_1$	$12 \pm 0.1$ ( .472 )

## TAPING DIMENSIONS

LTV-816-TP :



Description	Symbol	Dimensions in mm ( inches )
Tape wide	W	$16 \pm 0.3$ ( .63 )
Pitch of sprocket holes	$P_0$	$4 \pm 0.1$ ( .15 )
Distance of compartment	F	$7.5 \pm 0.1$ ( .295 )
Distance of compartment to compartment	$P_2$	$2 \pm 0.1$ ( .079 )
Distance of compartment to compartment	$P_1$	$12 \pm 0.1$ ( .472 )

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**ABSOLUTE MAXIMUM RATING**

( Ta = 25°C )

PARAMETER		SYMBOL	RATING	UNIT
INPUT	Forward Current	I <sub>F</sub>	50	mA
	Reverse Voltage	V <sub>R</sub>	6	V
	Power Dissipation	P	70	mW
OUTPUT	Collector - Emitter Voltage	V <sub>CEO</sub>	80	V
	Emitter - Collector Voltage	V <sub>ECO</sub>	6	V
	Collector Current	I <sub>c</sub>	50	mA
	Collector Power Dissipation	P <sub>c</sub>	150	mW
Total Power Dissipation		P <sub>tot</sub>	200	mW
*1	Isolation Voltage ○	V <sub>iso</sub>	5,000	V <sub>rms</sub>
Operating Temperature		T <sub>opr</sub>	-30 ~ +110	°C
Storage Temperature		T <sub>stg</sub>	-55 ~ +125	°C
*2	Soldering Temperature	T <sub>sol</sub>	260	°C

\*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

\*2. For 10 Seconds



## ELECTRICAL - OPTICAL CHARACTERISTICS

( Ta = 25°C )

PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
INPUT	Forward Voltage	V <sub>F</sub>	—	1.2	1.4	V	I <sub>F</sub> =20mA
	Reverse Current	I <sub>R</sub>	—	—	10	μA	V <sub>R</sub> =4V
	Terminal Capacitance	C <sub>t</sub>	—	30	250	pF	V=0, f=1KHz
OUTPUT	Collector Dark Current	I <sub>CEO</sub>	—	—	100	nA	V <sub>CE</sub> =20V, I <sub>F</sub> =0
	Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	80	—	—	V	I <sub>C</sub> =0.1mA I <sub>F</sub> =0
	Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	6	—	—	V	I <sub>E</sub> =10μA I <sub>F</sub> =0
TRANSFER CHARACTERISTICS	Collector Current	I <sub>C</sub>	2.5	—	30	mA	I <sub>F</sub> =5mA V <sub>CE</sub> =5V
	*1 Current Transfer Ratio ◇	CTR	50	—	600	%	
	Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	—	0.1	0.2	V	I <sub>F</sub> =20mA I <sub>C</sub> =1mA
	Isolation Resistance	R <sub>iso</sub>	5×10 <sup>10</sup>	1×10 <sup>11</sup>	—	Ω	DC500V 40 ~ 60% R.H.
	Floating Capacitance	C <sub>f</sub>	—	0.6	1	pF	V=0, f=1MHz
	Cut-Off Frequency	f <sub>c</sub>	—	80	—	kHz	V <sub>CE</sub> =5V, I <sub>C</sub> =2mA R <sub>L</sub> =100Ω, -3dB
	Response Time (Rise)	t <sub>r</sub>	—	4	18	μs	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA R <sub>L</sub> =100Ω
	Response Time (Fall)	t <sub>f</sub>	—	3	18	μs	

$$*1 \text{ CTR} = \frac{I_C}{I_F} \times 100\%$$

**RANK TABLE OF CURRENT TRANSFER RATIO CTR**

MODEL NO.	RANK MARK	CTR ( % )
LTV-816	L	50 ~ 100
	A	80 ~ 160
	B	130 ~ 260
	C	200 ~ 400
	D	300 ~ 600
	L or A or B or C or D	50 ~ 600

<b>CONDITIONS</b>	$I_F = 5 \text{ mA}$ $V_{CE} = 5 \text{ V}$ $T_a = 25 \text{ }^\circ\text{C}$
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## CHARACTERISTICS CURVES

Fig.1 Forward Current vs. Ambient Temperature

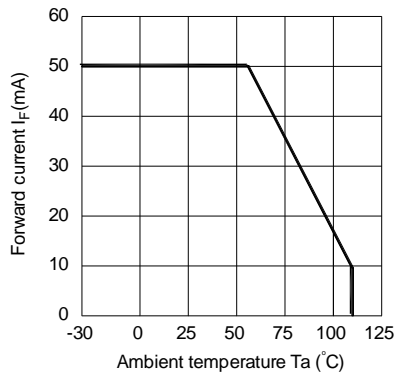


Fig.2 Collector Power Dissipation vs. Ambient Temperature

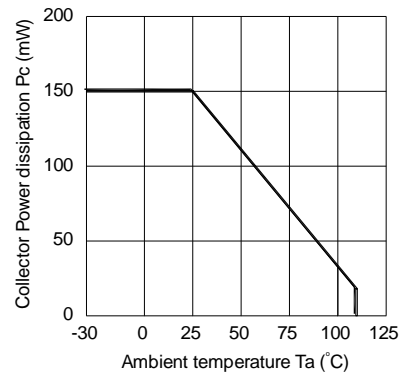


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

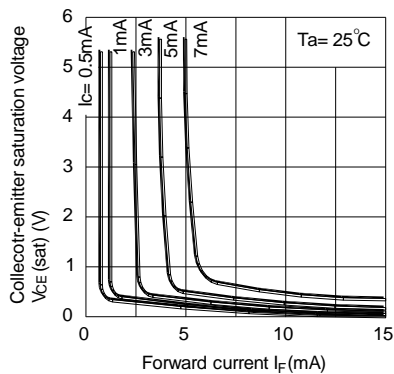


Fig.4 Forward Current vs. Forward Voltage

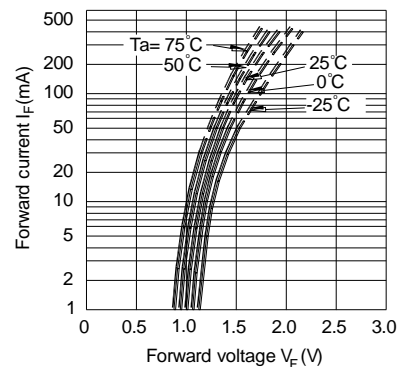


Fig.5 Current Transfer Ratio vs. Forward Current

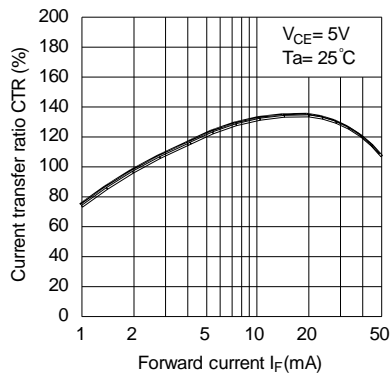
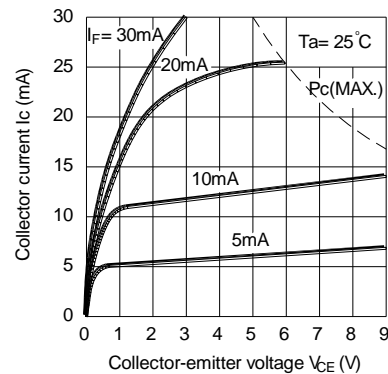


Fig.6 Collector Current vs. Collector-emitter Voltage



### CHARACTERISTICS CURVES

Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

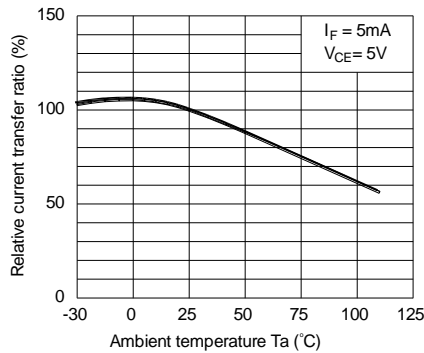


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

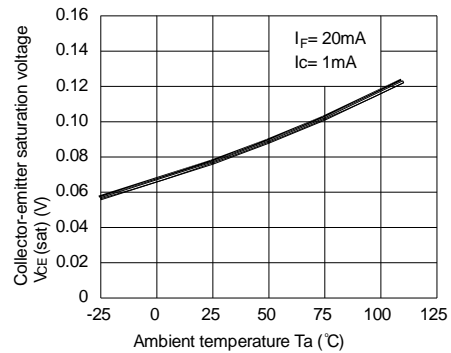


Fig.9 Collector Dark Current vs. Ambient Temperature

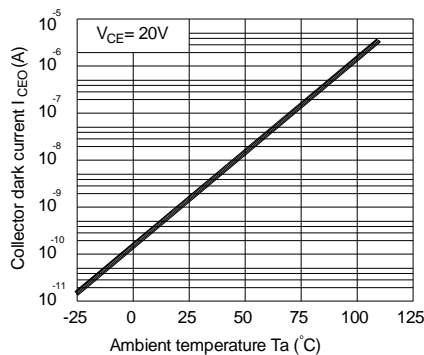


Fig.10 Response Time vs. Load Resistance

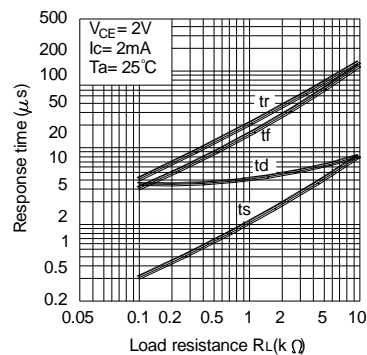
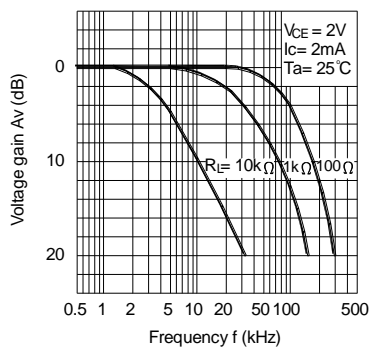
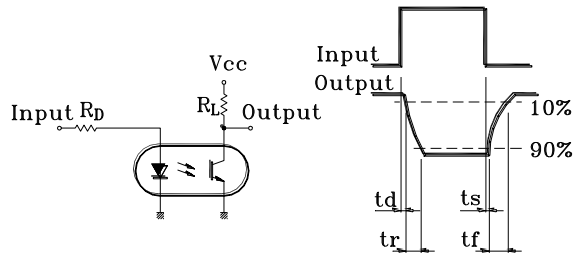


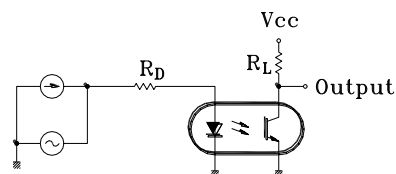
Fig.11 Frequency Response



Test Circuit for Response Time



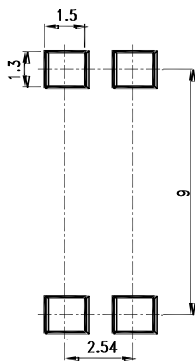
Test Circuit for Frequency Response



**RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)**

Unit : mm

4 PIN

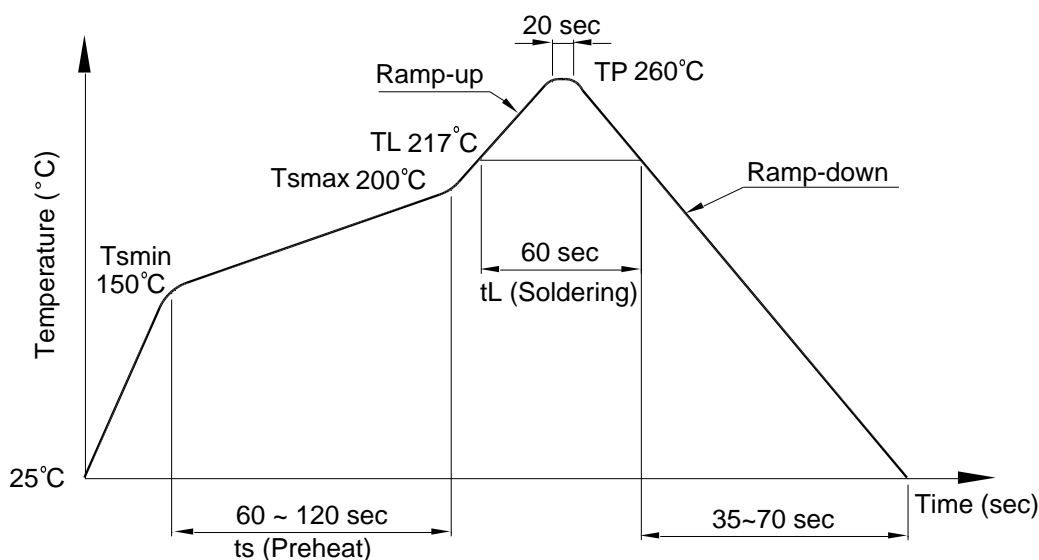


## TEMPERATURE PROFILE OF SOLDERING REFLOW

(1) IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below.

Profile item	Conditions
Preheat	
- Temperature Min ( $T_{Smin}$ )	150°C
- Temperature Max ( $T_{Smax}$ )	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature ( $T_L$ )	217°C
- Time ( $t_L$ )	60 sec
Peak Temperature ( $T_P$ )	260°C
Ramp-up rate	3°C /sec max.
Ramp-down rate	3~6°C / sec



### TEMPERATURE PROFILE OF SOLDERING REFLOW

#### (2) Wave soldering (JEDEC22A111 compliant)

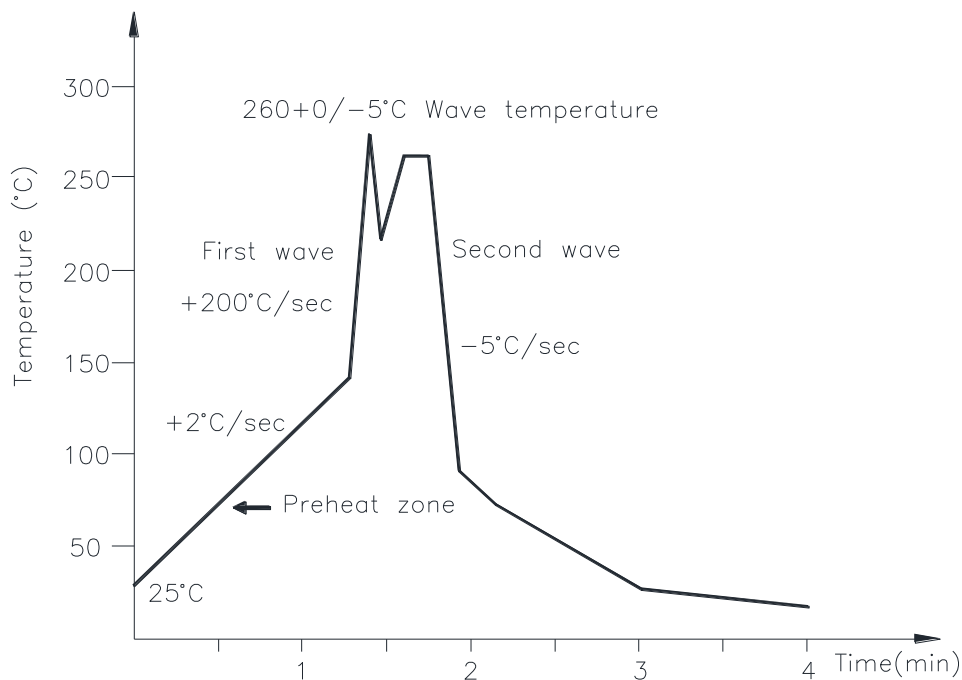
One time soldering is recommended within the condition of temperature.

Temperature:  $260+0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to  $140^{\circ}\text{C}$

Preheat time: 30 to 80 sec.



#### (3) Hand soldering by soldering iron

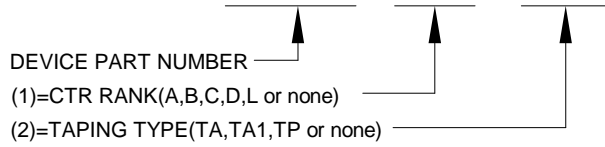
Allow single lead soldering in every single process. One time soldering is recommended.

Temperature:  $380+0/-5^{\circ}\text{C}$

Time: 3 sec max.

## NAMING RULE

LTV- 816-(1)-(2)





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